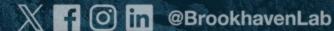




Toward HL-LHC: Advancing the ATLAS Inner Tracker (ITk) for the High-Luminosity Era

Mounia Laassiri

April 9th, 2024



Who am I?

- Mounia Laassiri
- 2011: B.Sc. in Physics
- 2013: M.Sc. in Security of Computer Networks and Embedded Systems

• 2019: Ph.D. in Physics and Nuclear Instrumentation

• 2022: Post-Doc at HIP

• POSEIDON– Position-sensitive detectors for nuclear fuel imaging

- 2024: Post-Doc at BNL
 - ATLAS Experiment and African School of Physics







Particle physics: what we know!

- The Standard Model (SM) of particle physics:
 - Defines elementary particles, and their interactions
- ATLAS and CMS experiments discovered the Higgs boson in 2012
 - Proved the existence of the last piece of the Standard Model
 - Made expected splash in the scientific community
 - Also made international news!



Observati with the

ATLAS Collal This paper is de contributions to Standard Model of Elementery Derticles

The New York Times

Physicists Find Elusive Particle Seen as Key to Universe



Scientists in Geneva on Wednesday applauded the discovery of a subatomic particle that looks like the Higgs boson. Pool photo by Denis Balibouse

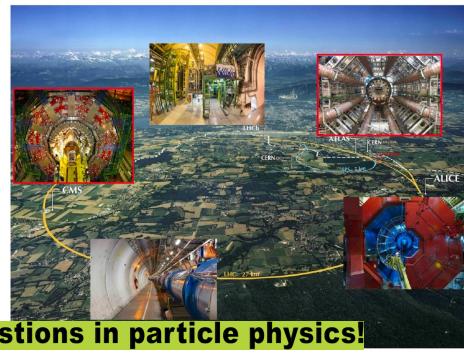
By Dennis Overbye

July 4, 2012

The Large Hadron Collider (LHC)

Need a **machine** capable of producing the particles we want to study...

- World's largest particle accelerator with 27 km circumference
- Collides **protons**, heavy ions. pp collisions at
- 7, 8, 13, now **13.6 TeV**
- Has four detectors stationed: (ALICE, ATLAS, CMS, LHCb)
- It's BIG
- It's EXPENSIVE
- What's it good for?



Answering the big questions in particle physics!



The ATLAS detector

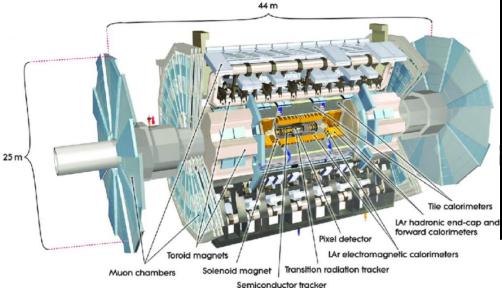
Particles produced at the LHC need to be reconstructed!

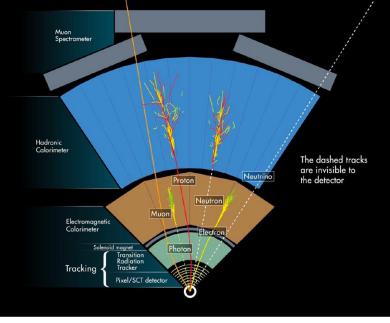
• Trackers + Calorimeters + Muon Spectrometer

Different layers detect different

particles (needed for different

final states!)

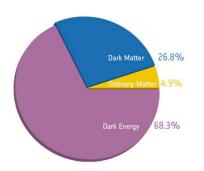






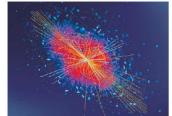
LHC future looks bright

- All experimental measurements agree with Standard Model predictions
- We still have many questions to answer!



What is dark matter?

What new particles and forces are out there?



+ more!

We need more data

To increase the precision of our measurements

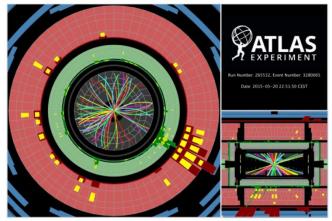
To increase the probability of seeing rare events

Upgrading to the High Luminosity LHC (HL-LHC), with 10x more proton-proton collisions!

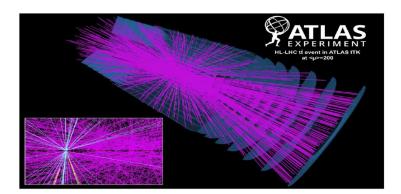


High-Luminosity LHC

- 2029: LHC will finish upgrade to High Luminosity LHC
- Pro: Will increase ATLAS + CMS datasets by ~ factor of 10
- Con: Extremely challenging data-taking environment
 - Extensive detector upgrades in progress to handle this



Current LHC: 20-30 collisions each time we cross beams

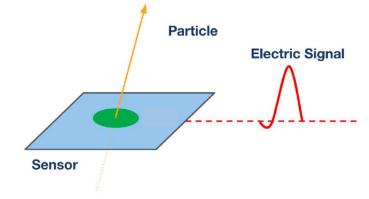


HL-LHC: up to 200 collisions each time we cross beams



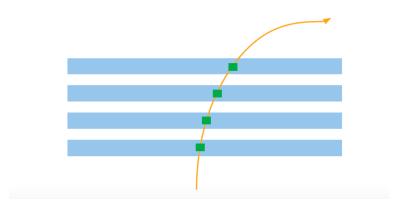
Silicon based tracking

- Particle hits silicon
- Electric signal read out
- Series of hits forms a track
- Use radius to measure particle momentum



G. D'amen - BNL physics seminar series

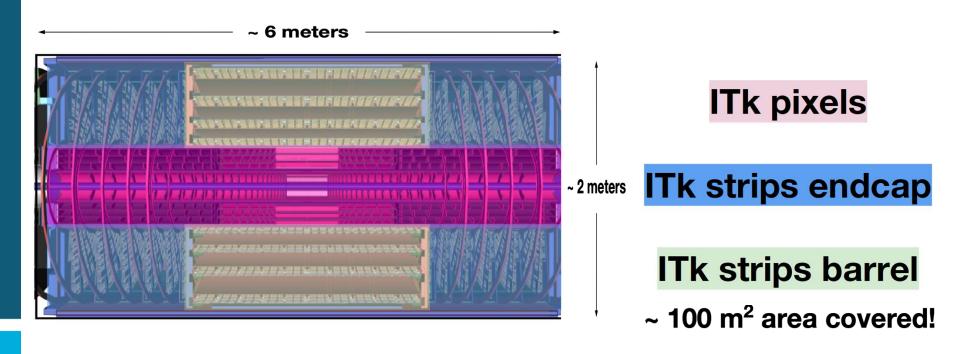
Silicon trackers actively used by ATLAS and CMS!





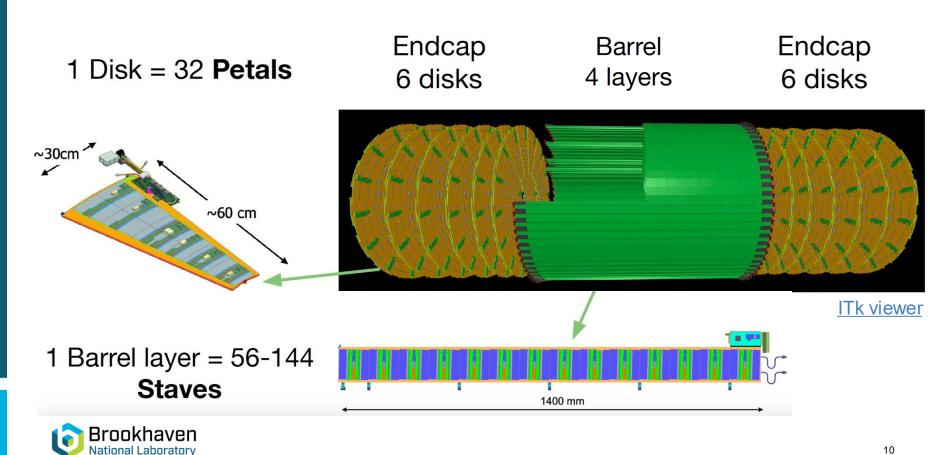
New ATLAS Inner Tracker (ITk)

 Part of ATLAS upgrade: Replace tracker with full silicon pixel and strip sub-detectors - The ITk (Inner Tracker):





ITK strips layout



ITK strips barrel layout

The ITk strips barrel will be made of four layers

Inner two layers: Higher granularity sensors

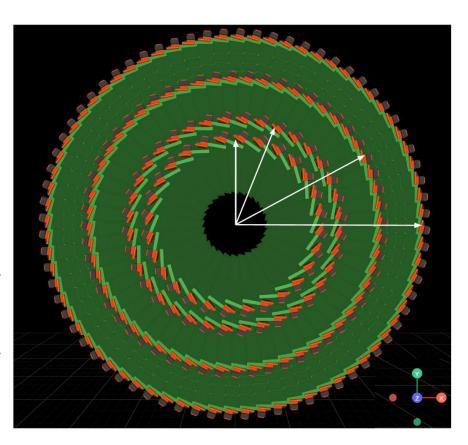
Outer two layers:

Lower granularity sensors

Layer	Radius [mm]	Channels in ϕ	Strip Pitch [μ m]	Strip Length [mm]
0	405	28×1280	75.5	24.1
1	562	40×1280	75.5	24.1
2	762	56×1280	75.5	48.2
3	1000	72×1280	75.5	48.2

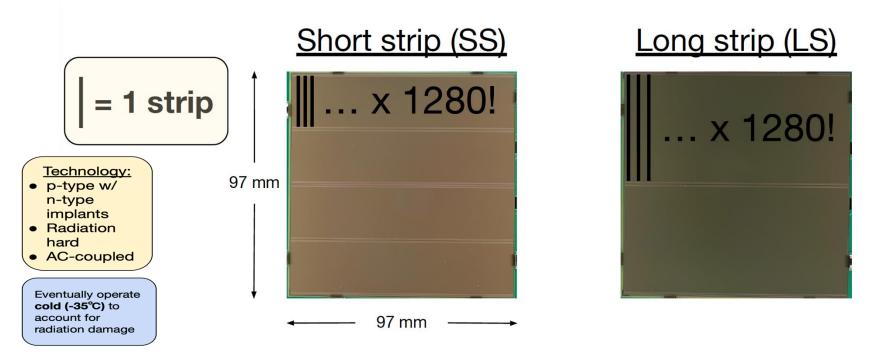
ATLAS-TDR-025





Sensors

 Detect particles at the strip level. Two flavors of barrel sensors:

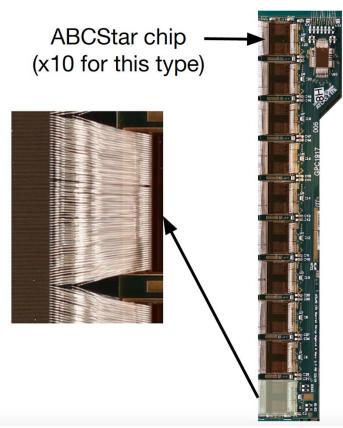


SS/LS: 4/2 rows of 1280 strips in same amount of area.



Hybrids

- Need to read out each strip
- Hybrid: Flex PCB glued onto sensors
- Hosts ASICs, called the ABCStar
 - Hybrid hosts 7-12 ABCStars, depending on hybrid/sensor flavor
- Wire-bonded to strips for individual readout!





Powerboards

- Need to power ASICs on hybrid
- Accomplished via a powerboard PCB housing various components:

DC-DC converter

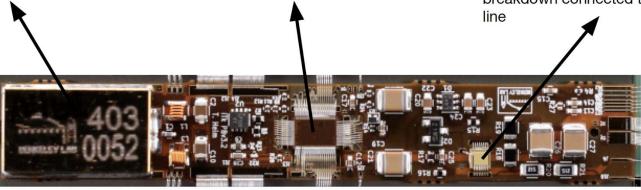
- 11V input, 1.5V output
- 110 μm Al shield to prevent EM noise leakage

Measurement and control

- Linear regulator for 11V → 1.4/3.3 V
- Enable/Disable DCDC
- Measure volage, current, temperature

HV filter

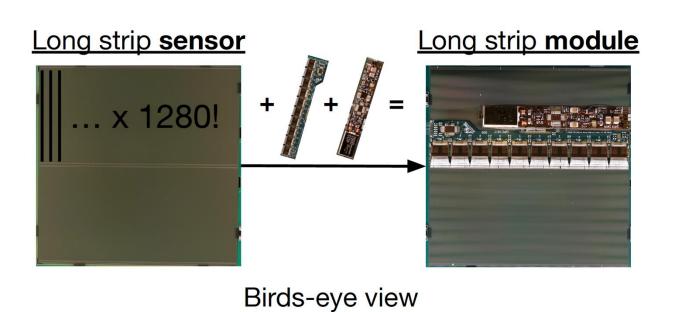
- Includes a GanFET (Gallium Nitride Front End Transistor)
- Allows isolation of failed sensor in breakdown connected to the same HV





Modules

- Let's put all it together!
 - Define this as a module:



ASICs

Hybrid, powerboard

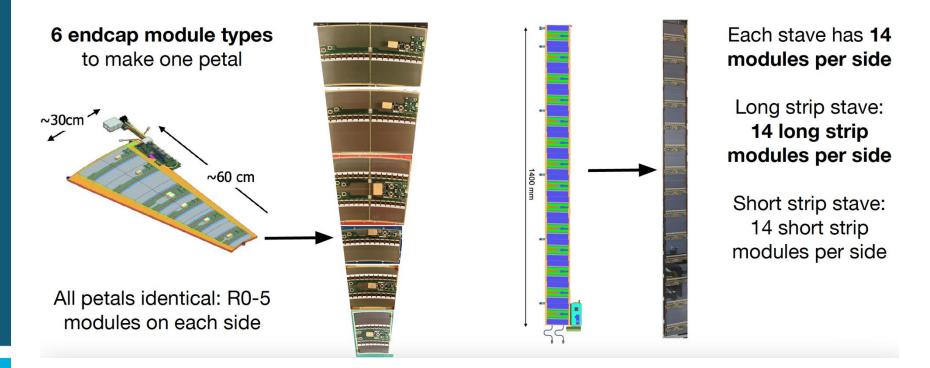
Sensor

Side view



All module flavors

Need appropriate module geometries to make up **petals** (endcap) and **staves** (barrel):





ITK at BNL

- At BNL, we **assemble** and **test** <u>modules</u> and <u>staves</u>
- 50% of strip barrel staves will be produced at BNL
- I work on module and stave testing—and investigating problems discovered during testing!
- Developing interlock systems to ensure safe thermal cycling of silicon strip modules, enhancing operational safety and reliability
- Serving as US contact of the coldjig software.

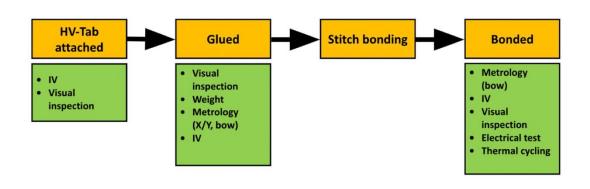




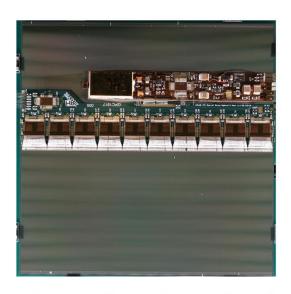


Module QC

Module QC tests are performed after each assembly step:



2024 JINST 15 P09004 [arXiv:2401.17054]



Completed module!



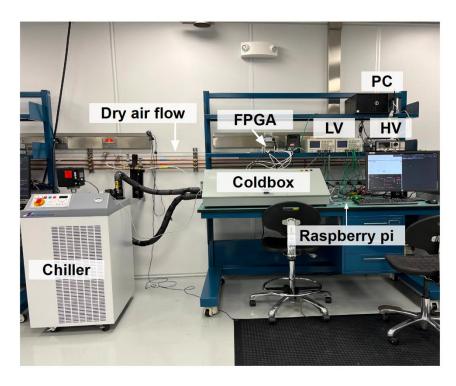


Module QC setup

 To perform these steps, need a robust and complete setup!

Module testing at BNL

- Coldbox (Modules go in here)
- Chiller (temp control)
- Dry air flow (humidity control)
- Power supplies to power electronics, bias sensors
- FPGA + PC for DAQ
- Raspberry pi: Environment monitoring

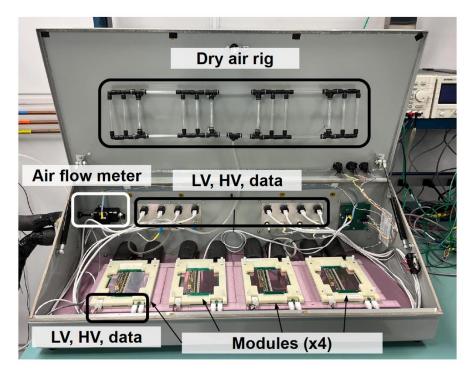




Module QC coldbox

Inside the coldbox

- Up to four modules
- Dry air rig (minimize humidity)
- Air flow meter (monitor)
- Module side LV, HV, data lines
- Box side LV, HV, data lines





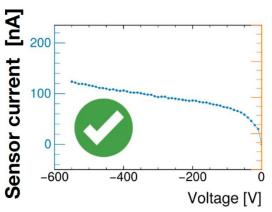
Module IV

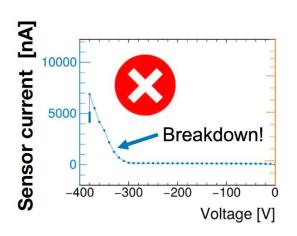
- Modules must be operational up to -500 volts
- First electrical test of a module: IV curve
 - Increase voltage in steps of -10V, measure sensor current

Bonded

- Metrology (bow)
- IV
- Visual inspection
- Electrical test
- Thermal cycling









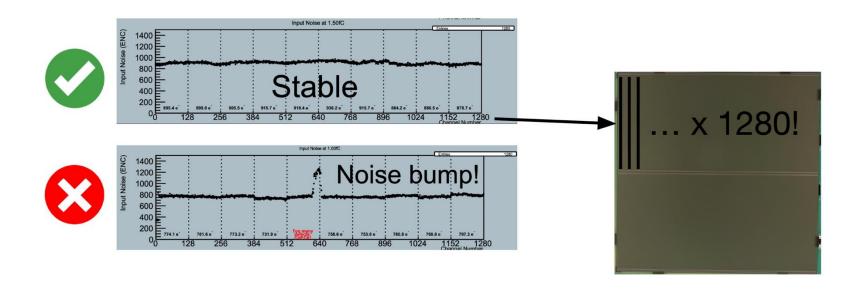


Module electrical test

- Modules must exhibit acceptable noise
- Bias sensor at -350V, inject test charges, measure gain, noise

Bonded

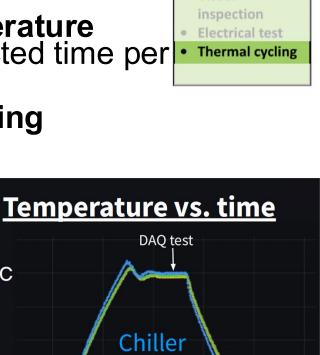
- Metrology (bow)
- 0 |V
- Visual inspection
- Electrical test
- Thermal cycling





Module thermal cycling

- Expect modules to experience temperature changes during operation (~ 1 expected time per year from year end shutdown)
- Emulate this effect with thermal cycling
- Define one thermal cycle as:
 - Start cold
 - Take noise measurement
 - Go warm
 - Take noise measurement
 - Go cold
 - Take noise measurement
- Module must undergo 10 thermal cycles and have passing noise and IV afterwards



Bonded

 Metrology (bow)



Chuck 1

Chuck 2

Chuck 3

Chuck 4

+20°C

-35°C

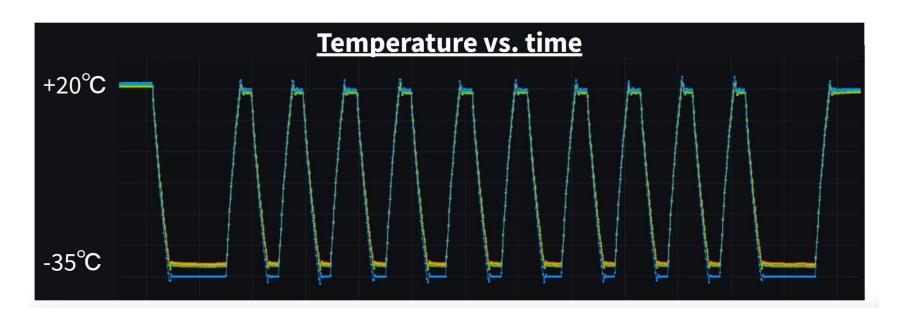
DAQ test

DAQ test

Module thermal cycling example

- **Bonded**
- Metrology (how)
- · IV
- Visual inspection
- Electrical test
- Thermal cycling

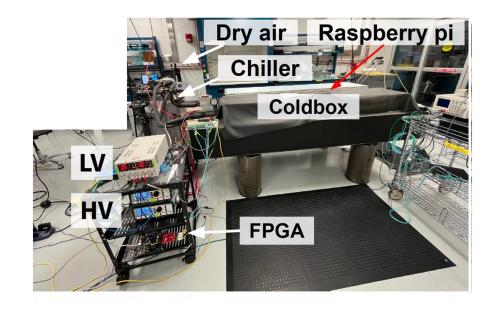
- Example set of ten thermal cycles
- Cycled four modules simultaneously
- Noise and IVs after TC looked good





Stave testing setup

- If modules pass all steps, load them onto stave/petal
- Need to ensure modules not affected during this step!
- No well-defined stave/petal QC procedure yet, but have testing setup:
- Example stave testing setup
 - Coldbox (Stave inside)
 - Chiller (temp control)
 - Dry air (humidity control)
 - Power supplies to power electronics, bias sensors
 - FPGA for DAQ
 - Raspberry pi: Environment monitoring



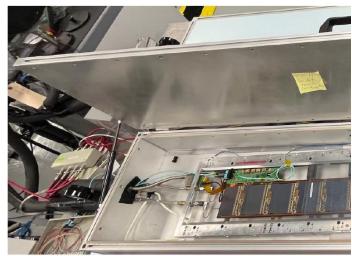


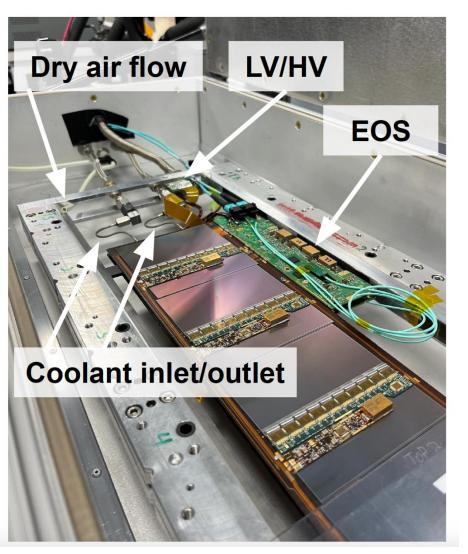
Stave coldbox

Inside the coldbox

- One stave
- Dry air flow (minimize humidity)
- Coolant inlet/outlet (temperature control)
- LV/HV connector
- End Of Substructure (EOS)

card for data raadout

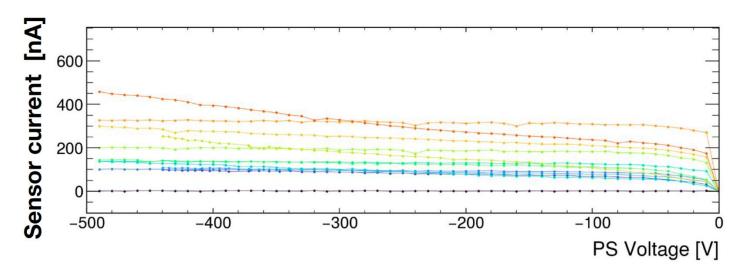






Stave IV

Can take IV of all modules simultaneously



- In this case, no modules in breakdown
- Varied current magnitudes among modules, partially expected from light leakage

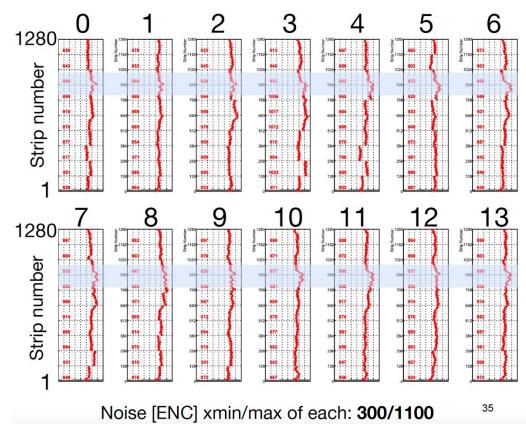


Stave electrical test

- Can take noise measurement of all modules simultaneously
- Example noise measurement for one

stave side (14 modules)

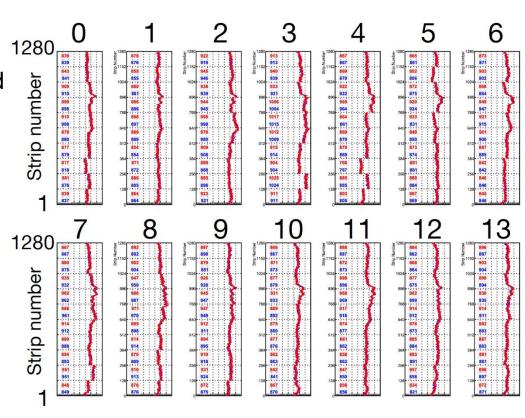
- X-axis ranges: 300-1100ENC
- Expected shape near
 DCDC coil
- Flat, ~ 900 ENC.
 Considered healthy noise for Long Strip stave





Stave TC

- Also plan to thermal cycle staves a number of times (number undefined, at least 5 times)
- Will compare noise before and after thermal cycling, just like for module TC
- In this example, TCd stave to inlet/outlet avg. temperature =
 -35°C 5 times
- Noise looks very similar before/after





Noise [ENC] xmin/max of each: 300/1100

Summary and the future of ATLAS

- BNL does critical work in assembly and testing of ITk Strips
- I am heavily involved in testing of ITk strip modules and staves at BNL & Developing interlock systems
- ITk should be installed and HL-LHC fully operational by the end of the decade

The more **robust** the **ITk**, the better the chance for **new** physics discoveries!



Thank you!

